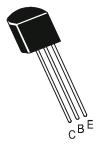


An ISO/TS16949 and ISO 9001 Certified Company



PNP SILICON PLANAR EPITAXIAL TRANSISTORS

BC556, A, B, C BC557, A, B, C BC558, A, B, C TO-92 Plastic Package



General Purpose Transistors

ABSOLUTE MAXIMUM RATINGS(Ta=25 deg C unless otherwise specified)

DESCRIPTION	SYMBOL	BC556	BC557	BC558	UNITS
Collector Emitter Voltage	V _{CEO}	65	45	30	V
Collector Emitter Voltage	V _{CES}	80	50	30	V
Collector Base Voltage	V _{CBO}	80	50	30	V
Emitter Base Voltage	V _{EBO}	5	5	5	V
Collector Current Continuous	I _C		100		mA
Peak	I _{CM}		200		mA
Base Current - Peak	I _{BM}		200		mA
Emitter Current - Peak	I _{EM}		200		mA
Collector Power Dissipation	P _{TA}		500		mW
Ta =25 deg C					
Operating And Storage Junction	T _j , T _{stg}		-55 to +150		٥C
Temperature Range					
-					
THERMAL RESISTANCE					
Junction to ambient	R _{th(j-a)}		250		°C/W

ELECTRICAL CHARACTERISTICS (Ta=25 deg C Unless Otherwise Specified)

DESCRIPTION	SYMBOL	TEST CONDITION	MIN	TYP	MAX	UNITS
Collector Emitter Voltage						
BC	556 V _{CEO}	$I_C=2mA,I_B=0$	65			V
ВС	557		45			V
ВС	558		30			V

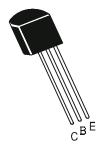
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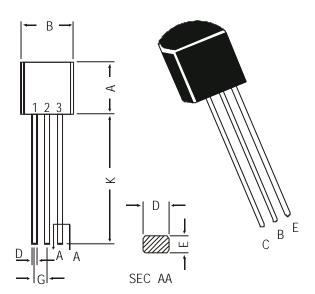
DESCRIPTION	SYMBOL	TEST CONDITION	MIN	TYP	MAX	UNITS
Collector Base Voltage						
BC556	V_{CBO}	I _C =100uA,I _E =0	80			V
BC557			50			V
BC558			30			V
Emitter Base Voltage	V_{EBO}	I _E =100uA, I _C =0	5			V
Collector Cut off Current	I _{CBO}	$V_{CB} = 30V, I_{E} = 0$			15	nA
		$V_{CB} = 30V, I_E = 0$			4	uA
		Tj= 150 deg C				
Collector Cut off Current						
BC556	I _{CES}	V _{CE} =80V		0.2	15	nA
BC557		V _{CE} =50V		0.2	15	nA
BC558		V _{CE} =30V		0.2	15	nA
BC556		V _{CE} =80V,Tj=125 ^O C			4	uA
BC557		V _{CE} =50V,Tj=125 ^O C			4	uA
BC558		V _{CE} =30V,Tj=125 ^O C			4	uA
DC Current Gain						
A	h _{FE}	V _{CE} =5V,I _C =10uA		90		
В				150		
С				270		
BC556		$V_{CE}=5V,I_{C}=2mA$	75		475	
BC557, BC558			75		800	
					1	
A			110	180	220	
В			200	290	450	
С			420	500	800	
A	h _{FE}	V _{CE} =5V,I _C =100mA		120	1	
В				200		
С				400		

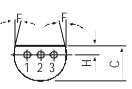
BC556, A, B, C BC557, A, B, C BC558, A, B, C TO-92 Plastic Package



DESCRIPTION	SYMBOL	TEST CONDITION	MIN	TYP	MAX	UNITS
Collector Emitter Saturation Voltage						
	V _{CE(sat)}	I _C =10mA,I _B =0.5mA		0.09	0.3	V
		I _C =100mA,I _B =5mA		0.25	0.65	V
Base Emitter Saturation Voltage	V _{BE(sat)}	I _C =10mA,I _B =0.5mA		0.70		V
		I _C =100mA,I _B =5mA		0.90		V
Base Emitter On Voltage	V _{BE(on)}	I _C =2mA,V _{CE} =5V	0.55	0.66	0.70	V
		I _C =10mA,V _{CE} =5V			0.82	V
DYNAMICS CHARACTERISTICS	SYMBOL	TEST CONDITION	MIN	TYP	MAX	UNITS
Transition Frequency	f _T	I _C =10mA, V _{CE} =5V				
		f=100MHz		150		MHz
Collector output Capacitance	C_{cbo}	$V_{CB} = 10V$, $f = 1MH_Z$			6	pF
Noise Figure	NF	$V_{CE} = 5V, I_{C} = 0.2mA$		2	10	dB
		$R_S=2K\Omega, f=1KH_{Z,}$				
		B =200H _Z				
Small Signal Current Gain						
	A h _{fe}	$V_{CE} = 5V, I_{C} = 2mA$		220		
I	3	f=1KHz		330		
	C			600		
Input Impedance						
	A h _{ie}	$V_{CE} = 5V, I_{C} = 2mA$	1.6	2.7	4.5	kΩ
	3	f=1KHz	3.2	4.5	8.5	
	C		6.0	8.7	15	
Voltage Feedback						
	A h _{re}	$V_{CE} = 5V, I_{C} = 2mA$		1.5		x10
	3	f=1KHz		2.0		
	C			3.0		
Output Admittance						
	A h _{oe}	$V_{CE} = 5V, I_{C} = 2mA$		18	30	u MHO
	3	f=1KHz		30	60	
				60	110	

TO-92 Plastic Package



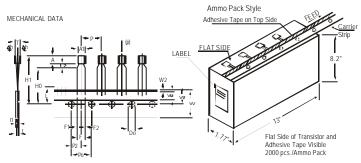


PIN CONFIGURATION

- 1. COLLECTOR
- 2. BASE
- 3. EMITTER

	DIM	MIN.	MAX.			
-	А	4.32	5.33			
	В	4.45	5.20			
	С	3.18	4.19			
	D	0.41	0.55			
mm	Е	0.35	0.50			
diminsions in mm.	F	5 DEG				
sion	G	1.14	1.40			
limin	Н	1.14	1.53			
All d	K	12.70	_			

TO-92 Transistors on Tape and Ammo Pack



All dimensions in mm unless specified otherwise

ITEM		SPECIFICATION				
ITEM	SYMBOL	MIN.	NOM.	MAX.	TOL.	REMARKS
BODY WIDTH	A1	4.0		4.8		
BODY HEIGHT	Α	4.8		5.2		
BODY THICKNESS	Ţ	3.9	40.7	4.2		
PITCH OF COMPONENT	Р		12.7		±1	
FEED HOLE PITCH	Po		12.7		±0.3	CUMULATIVE PITCH ERROR 1.0 mm/20 PITCH
FEED HOLE CENTRE TO COMPONENT CENTRE	P2		6.35		±0.4	
DISTANCE BETWEEN OUTER					+0.6	
LEADS	F		5.08		-0.2	
COMPONENT ALIGNMENT	Δh		0	1		AT TOP OF BODY
TAPE WIDTH	W		18		±0.5	
HOLD-DOWN TAPE WIDTH HOLE POSITION	Wo W1		6 9		±0.2 +0.7 -0.5	
HOLD-DOWN TAPE POSITION	W2		0.5		+0.2	
I FAD WIRF CLINCH HEIGHT	Ho		16		±0.2	
COMPONENT HEIGHT	H1			23.25	20.0	
LENGTH OF SNIPPED LEADS	L			11.0		
FEED HOLE DIAMETER	Do		4		±0.2	
TOTAL TAPE THICKNESS	t			1.2		t1 0.3 - 0.6
LEAD - TO - LEAD DISTANCEF1,	F2		2.54		+0.4 -0.1	
CLINCH HEIGHT	H2			3		
PULL - OUT FORCE	(P)	6N				

- 1. MAXIMUM ALIGNMENT DEVIATION BETWEEN LEADS NOT TO BE GREATER THAN 0.2 mm
- MAXIMUM ALON-CUMULATIVE VARIATION BETWEEN LEADS NOT TO BE GREATER THAN 0.2 IIIII.

 PITCHES.

 HOLDDOWN TAPE NOT TO EXCEED BEYOND THE EDGE(S) OF CARRIER TAPE AND THERE SHALL BE NO
- EXPOSURE OF ADHESIVE.

 4. NO MORE THAN 3 CONSECUTIVE MISSING COMPONENTS ARE PERMITTED.

 5. A TAPE TRAILER, HAVING AT LEAST THREE FEED HOLES ARE REQUIRED AFTER THE LAST COMPONENT.

- 6. SPLICES SHALL NOT INTERFERE WITH THE SPROCKET FEED HOLES.

Packing Detail

PACKAGE	STANDARD PACK		INNER CARTON BOX		OUTER CARTON BOX		

Notes

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Disclaimer

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